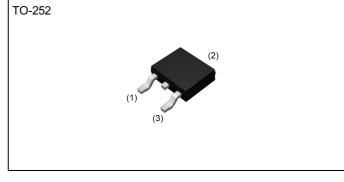
Nch 600V 11A Power MOSFET

V _{DSS}	600V
R _{DS(on)} (Max.)	390mΩ
I _D	±11A
P _D	124W

-

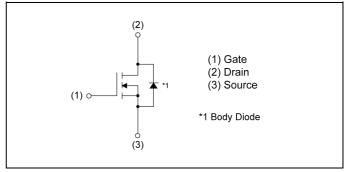


Features

- 1) Low on-resistance
- 2) Low radiation noise
- 3) Drive circuits can be simple
- 4) Parallel use is easy
- 5) Pb-free plating; RoHS compliant

•Inner circuit

Outline



Application

Switching

Packaging specifications

- i dokagiiig opoomodiioiio					
Packing	Embossed Tape				
Packing code	TL1				
Marking	R6011E				
Basic ordering unit (pcs)	2500				

ullet Absolute maximum ratings (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit	
Drain - Source voltage	V _{DSS}	600	V	
Continuous drain current (T _c = 25°C)	I _D *1	±11	Α	
Pulsed drain current		I _{DP} *2	±22	Α
Cata Sauma valtaga	static		±20	V
Gate - Source voltage	AC(f>1Hz)	V _{GSS}	±30	V
Avalanche current, single pulse		I _{AS}	1.8	Α
Avalanche energy, single pulse		E _{AS} *3	210	mJ
Power dissipation (T _c = 25°C)	P _D	124	W	
Junction temperature	T _j	150	°C	
Operating junction and storage tempera	ature range	T _{stg}	-55 to +150	°C

●Thermal resistance

Davamatav	Cymah al	Values			l lesit
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R _{thJC} *4	-	-	1.0	°C/W
Thermal resistance, junction - ambient	R _{thJA}	-	-	147	°C/W
Soldering temperature, wavesoldering for 10s	T _{sold}	-	-	265	°C

● Electrical characteristics (T_a = 25°C)

Parameter	Cumb al	Conditions	Values			Unit
- Farameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Drain - Source breakdown voltage	$V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$		600	-	-	V
		V _{DS} = 600V, V _{GS} = 0V				
Zero gate voltage drain current	I _{DSS}	$T_j = 25^{\circ}C$	-	-	100	μΑ
		$T_j = 125^{\circ}C$	-	-	1000	
Gate - Source leakage current	I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	±100	nA
Gate threshold voltage	Gate threshold voltage V _{GS(th)}		2	1	4	٧
		V _{GS} = 10V, I _D = 3.8A				
Static drain - source on - state resistance	R _{DS(on)} *6	$T_j = 25^{\circ}C$	-	340	390	mΩ
		$T_j = 125^{\circ}C$	-	720	-	
Gate resistance	R_{G}	f = 1MHz, open drain	-	7.7	-	Ω

● Electrical characteristics (T_a = 25°C)

Davamatar	Cymah al	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	UTIIL	
Forward Transfer Admittance	$ Y_{fs} ^{*6}$ $V_{DS} = 10V, I_D = 5.5A$		3.0	6.0	-	S	
Input capacitance	C _{iss}	V _{GS} = 0V	-	670	-		
Output capacitance	C _{oss}	V _{DS} = 25V	-	570	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	70	-		
Turn - on delay time	t _{d(on)} *6	$V_{DD} \simeq 300V$, $V_{GS} = 10V$	-	25	-		
Rise time	t _r *6	I _D = 5.5A	-	40	-	20	
Turn - off delay time	t _{d(off)} *6	R _L ≃ 54.9Ω	-	90	-	ns	
Fall time	t _f *6	$R_G = 10\Omega$	-	35	-		

● Gate charge characteristics (T_a = 25°C)

Downwater	Company of	Conditions	Values			Lloit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	Q _g *6	V _{DD} ≈ 300V	-	32	-	
Gate - Source charge Q _{gs}		I _D = 11A	-	5	-	nC
Gate - Drain charge	Q _{gd} *6	V _{GS} = 10V	-	17	-	
Gate plateau voltage	V _(plateau)	V _{DD} ≈ 300V, I _D = 11A	-	6.0	-	V

^{*1} Limited only by maximum channel temperature allowed

^{*2} Pw ≤ 10µs, Duty cycle ≤ 1%

^{*3} L \doteqdot 100mH, V_{DD}=50V, R_G=25 Ω , STARTING T_i=25 $^{\circ}$ C

^{*4} T_C=25°C

^{*5} Mounted on a epoxy PCB FR4 (25mm x 27mm x 0.8mm)

^{*6} Pulsed

● Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Symbol	Conditions		Unit			
- Farameter	Symbol	Conditions	Min.	Тур.	Max.	Offic	
Source current	I _S *1	T _C = 25°C	-	-	11	Α	
Pulsed source current	l _{SP} *2	1C - 23 C	-	-	22	Α	
Source-Drain voltage	V _{SD} *6	$V_{GS} = 0V, I_{S} = 11A$	-	-	1.5	V	
Reverse recovery time	t _{rr} *6		-	430	-	ns	
Reverse recovery charge	Q _{rr} *6	I _S = 11A di/dt = 100A/μs	-	4.5	-	μC	
Peak reverse recovery current	_{rr} *6		-	22	-	Α	

Fig.1 Power Dissipation Derating Curve

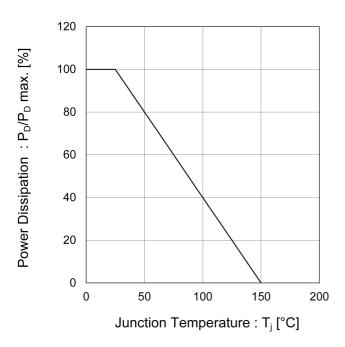


Fig.2 Drain Current Derating
Curve vs. Junction Temperature

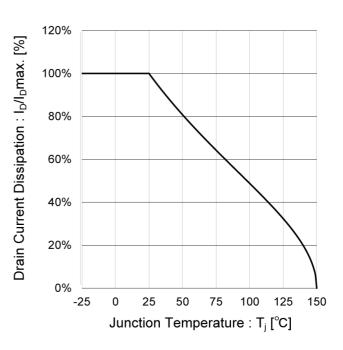


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

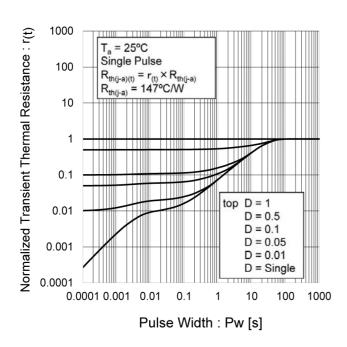
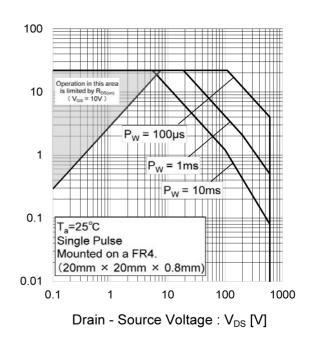


Fig.4 Maximum Safe Operating Area



Drain Current : I_D [A]

Fig.5 Avalanche Energy Derating
Curve vs. Junction Temperature

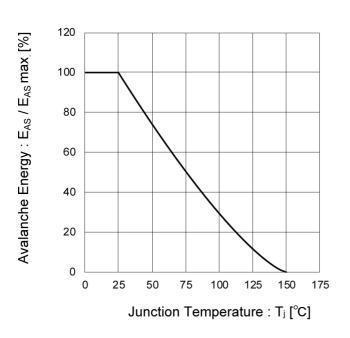


Fig.6 Breakdown Voltage vs.
Junction Temperature

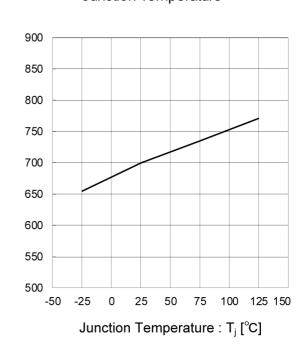
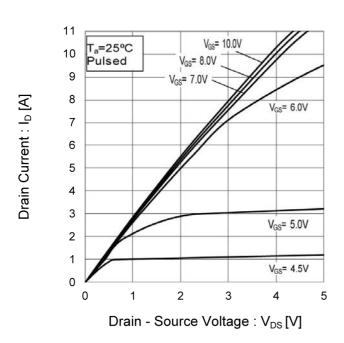


Fig.7 Typical Output Characteristics(I)



Drain Current : I_D [A]

Drain-Source Breakdown Voltage: V_{(BR)DSS} [V]

11 V_{GS}= 10.0V T_a=25℃ 10 V_{GS}= 8.0V Pulsed 9 V_{GS}= 7.0V V_{GS}= 6.0V 8 7 6 5 V_{GS}= 5.0V 4 3 2 V_{GS}= 4.5V 1 0 10 20 0 30 50 Drain - Source Voltage: V_{DS}[V]

Fig.8 Typical Output Characteristics(II)

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Fig.9 Typical Transfer Characteristics

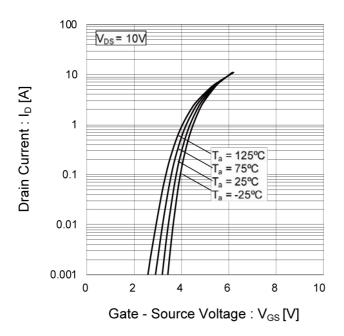


Fig.10 Gate Threshold Voltage vs.
Junction Temperature

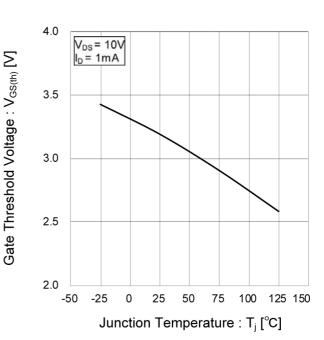


Fig.11 Forward Transfer Admittance vs.
Drain Current

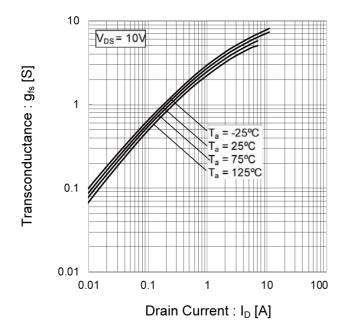


Fig.12 Static Drain - Source On - State Resistance vs. Drain Current

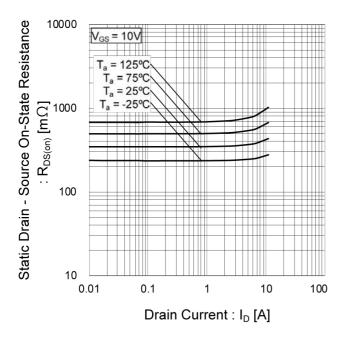


Fig.13 Static Drain - Source On - State Resistance vs. Gate Source Voltage

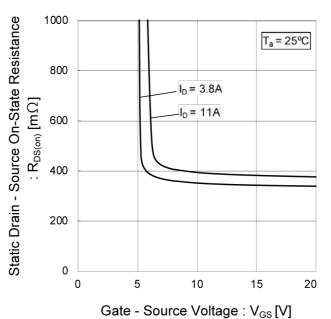


Fig.14 Static Drain - Source On - State Resistance vs. Junction Temperature

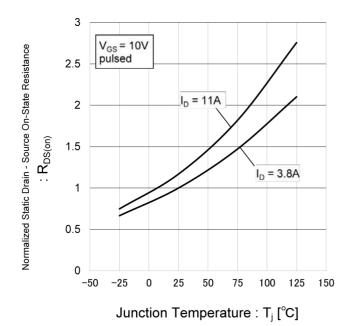


Fig.15 Typical Capacitance vs.

Drain - Source Voltage

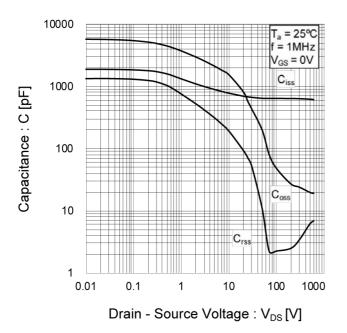


Fig.16 Switching Characteristics

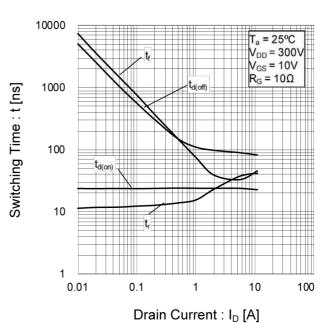
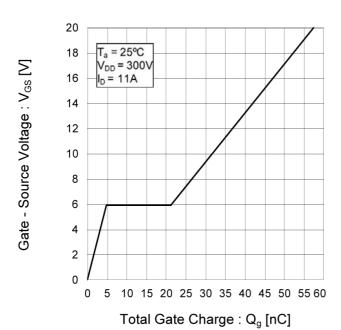
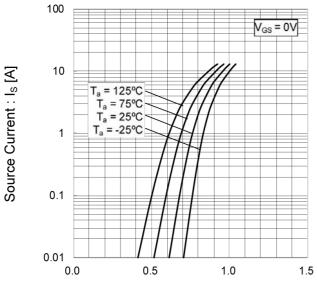


Fig.17 Typical Gate Charge



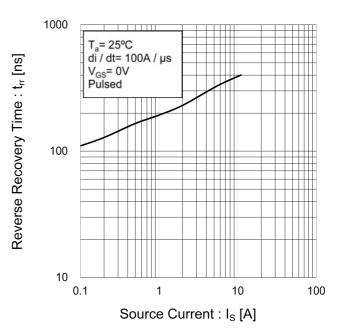
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Fig.18 Source Current vs. Source - Drain Voltage



Source - Drain Voltage : V_{SD} [V]

Fig.19 Reverse Recovery Time vs. Source Current



Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

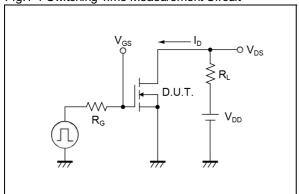


Fig.2-1 Gate Charge Measurement Circuit

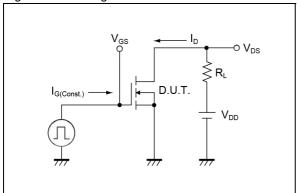


Fig.3-1 Avalanche Measurement Circuit

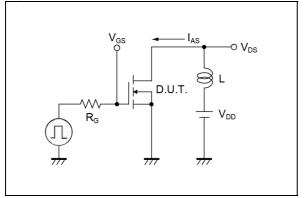


Fig.4-1 trr Measurement Circuit

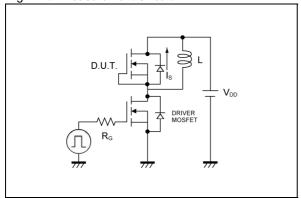


Fig.1-2 Switching Waveforms

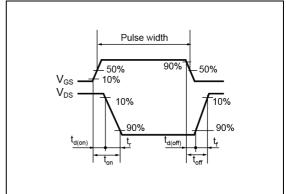


Fig.2-2 Gate Charge Waveform

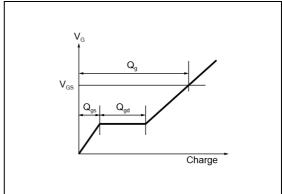


Fig.3-2 Avalanche Waveform

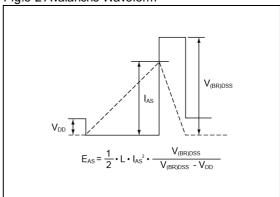
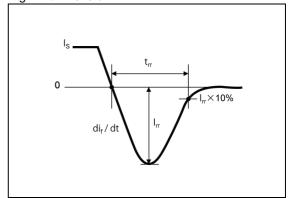
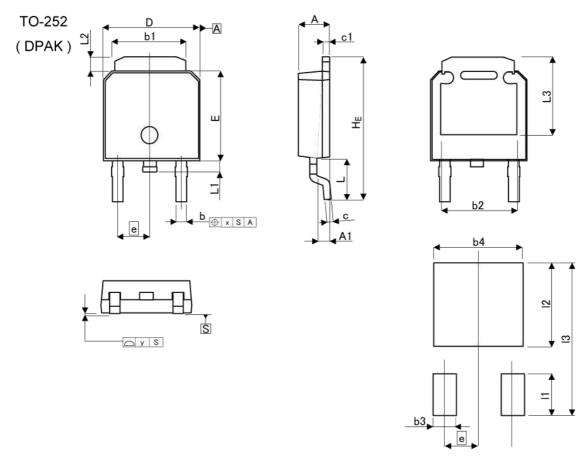


Fig.4-2 trr Waveform



Dimensions



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM -	MILIME	ETERS	INCHES		
ן ואוט	MIN	MAX	MIN	MAX	
Α	2.20	2.40	0.087	0.094	
A1	0.70	1.10	0.028	0.043	
b	0.60	0.90	0.024	0.035	
b1	5.20	5.50	0.205	0.217	
b2	4.	80	0.1	89	
С	0.40	0.60	0.016	0.024	
c1	0.40	0.60	0.016	0.024	
D	6.40	6.80	0.252	0.268	
е	2.	30	0.0	91	
E	6.00	6.40	0.236	0.252	
HE	9.40	10.40	0.370	0.409	
L	2.	90	0.1	14	
L1	0.60	1.00	0.024	0.039	
L2	0.70	1.30	0.028	0.051	
L3	5.	30	0.209		
х	÷	0.25	X (#)	0.010	
у	8	0.10	(5)	0.004	
DIA	MILIME	ETERS	INCI	HES	
DIM	MIN	MAX	MIN	MAX	
b3	-	1.15	9#8	0.045	
b4	-	5.55	0.70	0.219	
11	-	2.77	S (#3)	0.109	
12	8	5.50	(8)	0.217	
13	#	10.40	7E0	0.409	

Dimension in mm/inches



Notice

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Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSIII	CLASS II b	CLASSIII
CLASSIV	CLASSIII	CLASSⅢ	CLASSII

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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